CS5253-1

3.0 A LDO 5-Pin Adjustable Linear Regulator

This new very low dropout linear regulator reduces total power dissipation in the application. To achieve very low dropout, the internal pass transistor is powered separately from the control circuitry. Furthermore, with the control and power inputs tied together, this device can be used in single supply configuration and still offer a better dropout voltage than conventional PNP–NPN based LDO regulators. In this mode the dropout is determined by the minimum control voltage.

The CS5253–1 is offered in a five–terminal D^2PAK package, which allows for the implementation of a remote–sense pin permitting very accurate regulation of output voltage directly at the load, where it counts, rather than at the regulator. This remote sensing feature virtually eliminates output voltage variations due to load changes and resistive voltage drops. Typical load regulation measured at the sense pin is less than 1.0 mV for an output voltage of 2.5 V with a load step of 10 mA to 3.0 A.

The CS5253–1 has a very fast transient loop response which can be adjusted using a small capacitor on the Adjust pin.

Internal protection circuitry provides for "bust–proof" operation, similar to three–terminal regulators. This circuitry, which includes overcurrent, short circuit, and overtemperature protection will self protect the regulator under all fault conditions.

The CS5253–1 is ideal for generating a 2.5 V supply to power graphics controllers used on VGA cards.

Features
- V_{OUT} Range Is 1.25 V to 5.0 V @ 3.0 A
- V_{POWER} Dropout < 0.40 V @ 3.0 A
- $V_{CONTROL}$ Dropout < 1.05 V @ 3.0 A
- 1.0% Trimmed Reference
- Fast Transient Response
- Remote Voltage Sensing
- Thermal Shutdown
- Current Limit
- Short Circuit Protection
- Drop–In Replacement for EZ1582
- Backwards Compatible with 3–Pin Regulators
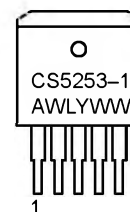- Very Low Dropout Reduces Total Power Consumption

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Tab = V_{OUT}
Pin 1. V_{SENSE}
2. Adjust
3. V_{OUT}
4. $V_{CONTROL}$
5. V_{POWER}
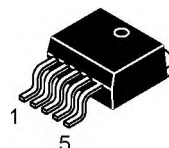
**D^2PAK
5–PIN
DP SUFFIX
CASE 936F**

MARKING DIAGRAM

CS5253–1
AWLYWW

A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

ORDERING INFORMATION

Device	Package	Shipping
CS5253–1GDP5	D^2PAK^*	50 Units/Rail
CS5253–1GDPR5	D^2PAK^*	750 Tape & Reel

*5–Pin.

CS5253–1
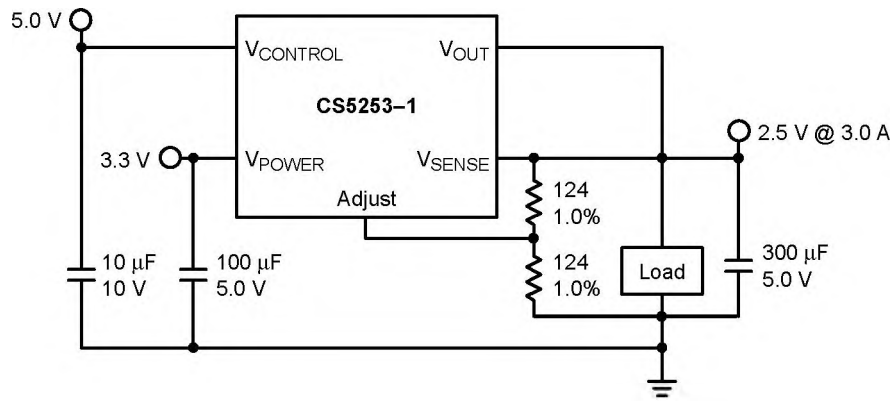
Figure 1. Application Diagram

ABSOLUTE MAXIMUM RATINGS*

Rating	Value	Unit
V_{POWER} Input Voltage	6.0	V
$V_{CONTROL}$ Input Voltage	13	V
Operating Junction Temperature Range, T_J	0 to 150	°C
Storage Temperature Range	–65 to +150	°C
ESD Damage Threshold	2.0	kV
Lead Temperature Soldering: Reflow: (SMD styles only) (Note 1)	230 peak	°C

1. 60 second maximum above 183°C.

*The maximum package power dissipation must be observed.

ELECTRICAL CHARACTERISTICS (0°C ≤ T_A ≤ 70°C; 0°C ≤ T_J ≤ 150°C; V_{SENSE} = V_{OUT} and V_{ADJ} = 0 V; unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
CS5253–1					
Reference Voltage	$V_{CONTROL}$ = 2.75 V to 12 V, V_{POWER} = 2.05 V to 5.5 V, I_{OUT} = 10 mA to 3.0 A	1.237 (–1.0%)	1.250	1.263 (+1.0%)	V
Line Regulation	$V_{CONTROL}$ = 2.5 V to 12 V, V_{POWER} = 1.75 V to 5.5 V, I_{OUT} = 10 mA	–	0.02	0.2	%
Load Regulation	$V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, I_{OUT} = 10 mA to 3.0 A, with Remote Sense	–	0.04	0.3	%
Minimum Load Current (Note 2)	$V_{CONTROL}$ = 5.0 V, V_{POWER} = 3.3 V, ΔV_{OUT} = +1.0%	–	5.0	10	mA
Control Pin Current (Note 3)	$V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, I_{OUT} = 100 mA $V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, I_{OUT} = 3.0 A	– –	6.0 35	10 120	mA mA
Adjust Pin Current	$V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, I_{OUT} = 10 mA	–	60	120	μA
Current Limit	$V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, ΔV_{OUT} = –1.0%	3.1	4.0	–	A
Short Circuit Current	$V_{CONTROL}$ = 2.75 V, V_{POWER} = 2.05 V, V_{OUT} = 0 V	2.0	3.5	–	A
Ripple Rejection (Note 4)	$V_{CONTROL}$ = V_{POWER} = 3.25 V, V_{RIPPLE} = 1.0 $V_{P–P}$ @ 120 Hz, I_{OUT} = 4.0 A, C_{ADJ} = 0.1 μF	60	80	–	dB

2. The minimum load current is the minimum current required to maintain regulation. Normally the current in the resistor divider used to set the output voltage is selected to meet the minimum load current requirement.

3. The $V_{CONTROL}$ pin current is the drive current required for the output transistor. This current will track output current with roughly a 1:100 ratio. The minimum value is equal to the quiescent current of the device.

4. This parameter is guaranteed by design and is not 100% production tested.

ELECTRICAL CHARACTERISTICS (continued) ($0°C \le T_A \le 70°C$; $0°C \le T_J \le 150°C$; $V_{SENSE} = V_{OUT}$ and $V_{ADJ} = 0$ V; unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
CS5253–1					
Thermal Regulation	30 ms Pulse, $T_A = 25°C$	–	0.002	–	%/W
$V_{CONTROL}$ Dropout Voltage (Minimum $V_{CONTROL} - V_{OUT}$) (Note 5)	$V_{POWER} = 2.05$ V, $I_{OUT} = 100$ mA $V_{POWER} = 2.05$ V, $I_{OUT} = 1.0$ A $V_{POWER} = 2.05$ V, $I_{OUT} = 3.0$ A	– – –	0.90 1.00 1.05	1.15 1.15 1.30	V V V
V_{POWER} Dropout Voltage (Minimum $V_{POWER} - V_{OUT}$) (Note 5)	$V_{CONTROL} = 2.75$ V, $I_{OUT} = 100$ mA $V_{CONTROL} = 2.75$ V, $I_{OUT} = 1.0$ A $V_{CONTROL} = 2.75$ V, $I_{OUT} = 3.0$ A	– – –	0.05 0.15 0.40	0.15 0.25 0.60	V V V
RMS Output Noise	Freq = 10 Hz to 10 kHz, $T_A = 25°C$	–	0.003	–	%V_{OUT}
Temperature Stability	–	0.5	–	–	%
Thermal Shutdown (Note 6)	–	150	180	210	°C
Thermal Shutdown Hysteresis	–	–	25	–	°C
$V_{CONTROL}$ Supply Only Output Current	$V_{CONTROL} = 13$ V, V_{POWER} Not Connected, $V_{ADJ} = V_{OUT} = V_{SENSE} = 0$ V	–	–	50	mA
V_{POWER} Supply Only Output Current	$V_{POWER} = 6.0$ V, $V_{CONTROL}$ Not Connected, $V_{ADJ} = V_{OUT} = V_{SENSE} = 0$ V	–	0.1	1.0	mA

5. Dropout is defined as either the minimum control voltage ($V_{CONTROL}$) or minimum power voltage (V_{POWER}) to output voltage differential required to maintain 1.0% regulation at a particular load current.

6. This parameter is guaranteed by design, but not parametrically tested in production. However, a 100% thermal shutdown functional test is performed on each part.

PACKAGE PIN DESCRIPTION

| PACKAGE PIN # D²PAK	PIN SYMBOL	FUNCTION
1	V_{SENSE}	This Kelvin sense pin allows for remote sensing of the output voltage at the load for improved regulation. It is internally connected to the positive input of the voltage sensing error amplifier.
2	Adjust	This pin is connected to the low side of the internally trimmed 1.0% bandgap reference voltage and carries a bias current of about 50 μA. A resistor divider from Adjust to V_{OUT} and from Adjust to ground sets the output voltage. Also, transient response can be improved by adding a small bypass capacitor from this pin to ground.
3	V_{OUT}	This pin is connected to the emitter of the power pass transistor and provides a regulated voltage capable of sourcing 3.0 A of current.
4	$V_{CONTROL}$	This is the supply voltage for the regulator control circuitry. For the device to regulate, this voltage should be between 0.9 V and 1.3 V (depending on the output current) greater than the output voltage. The control pin current will be about 1.0% of the output current.
5	V_{POWER}	This is the power input voltage. This pin is physically connected to the collector of the power pass transistor. For the device to regulate, this voltage should be between 0.1 V and 0.6 V greater than the output voltage depending on the output current. The output load current of 3.0 A is supplied through this pin.
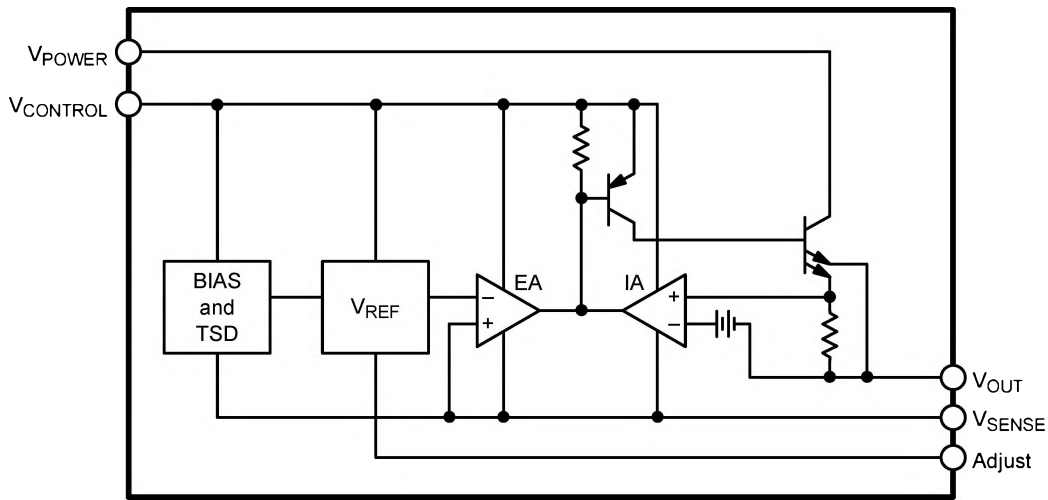
Figure 2. Block Diagram
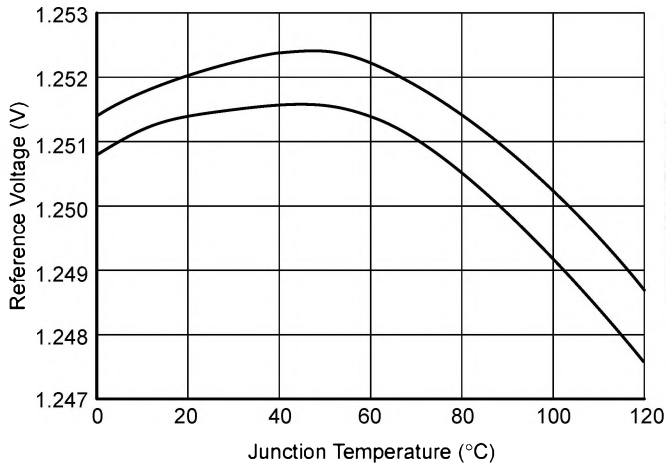
TYPICAL PERFORMANCE CHARACTERISTICS

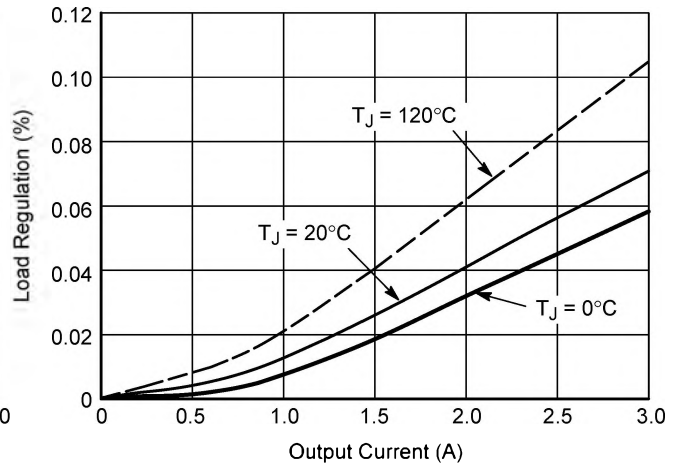Figure 3. Reference Voltage vs Junction Temperature

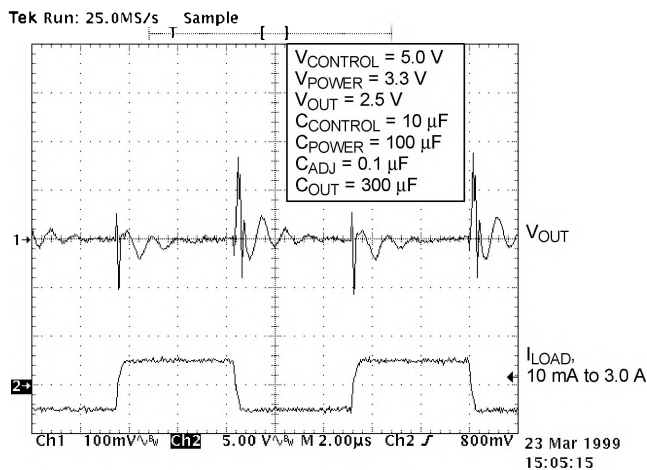Figure 4. Load Regulation vs Output Current

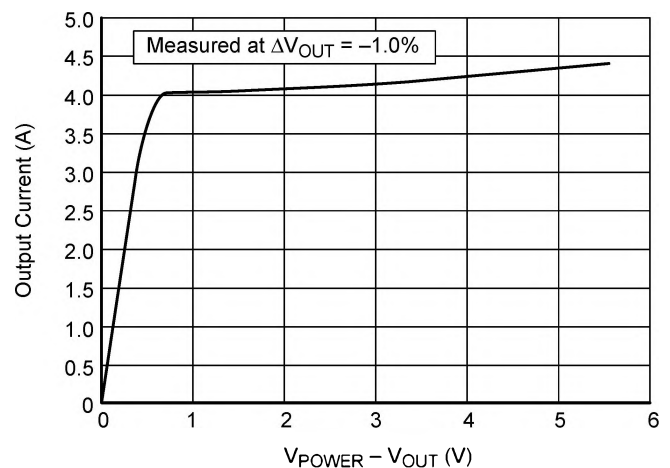

Figure 5. Transient Response

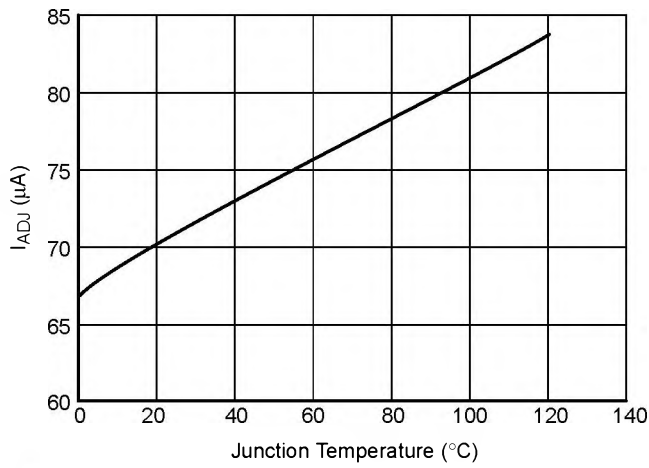Figure 6. Output Current vs $V_{POWER} - V_{OUT}$

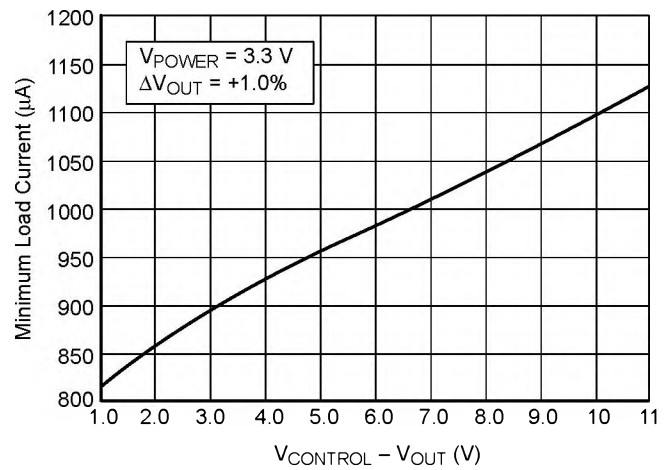Figure 7. Adjust Pin Current vs Junction Temperature

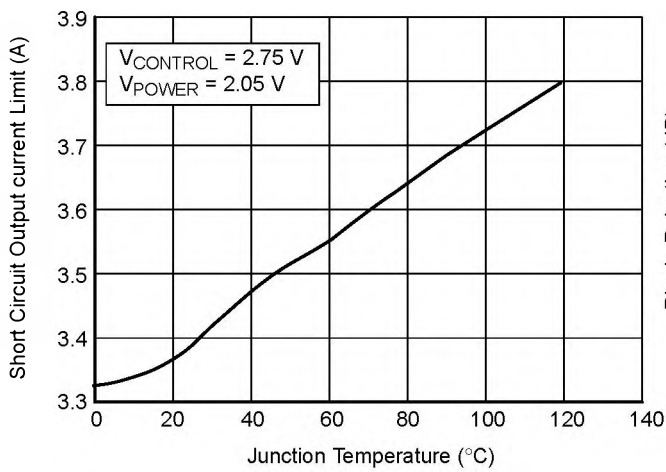Figure 8. Minimum Load Current vs $V_{CONTROL} - V_{OUT}$

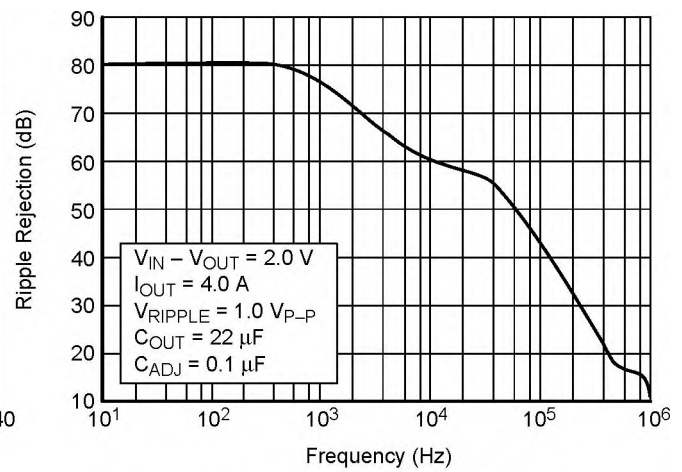Figure 9. Short Circuit Output Current vs Junction Temperature
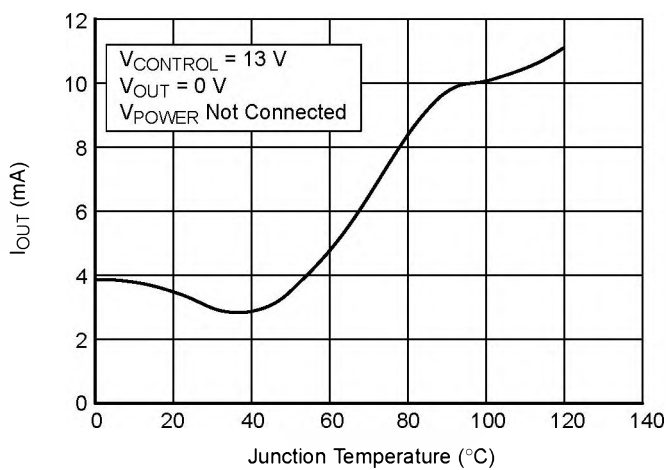

Figure 10. Ripple Rejection vs Frequency

Figure 11. $V_{CONTROL}$ Only Output Current vs Junction Temperature
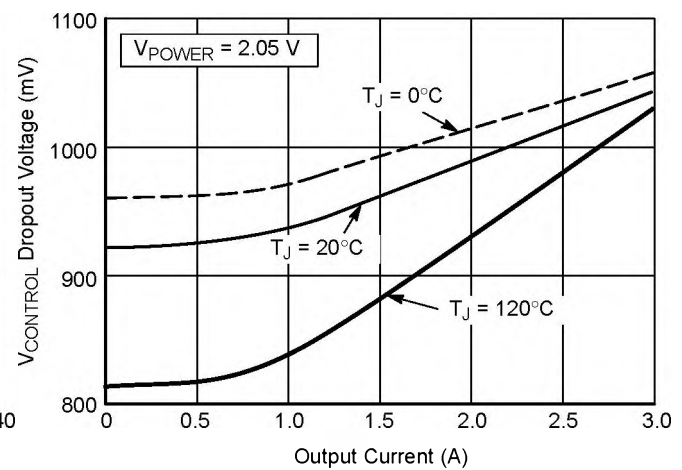

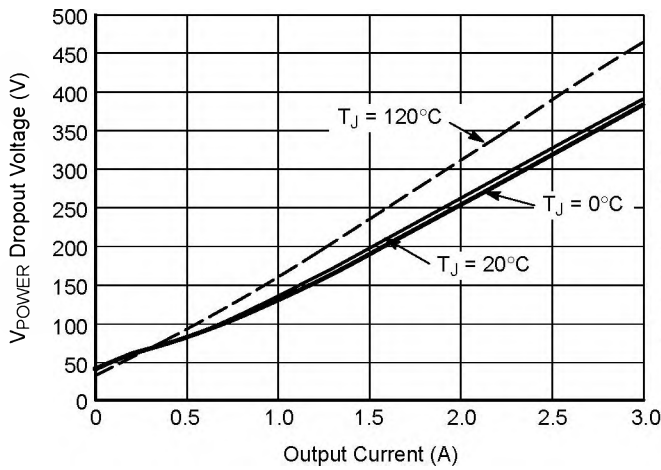Figure 12. $V_{CONTROL}$ Dropout Voltage vs Output Current

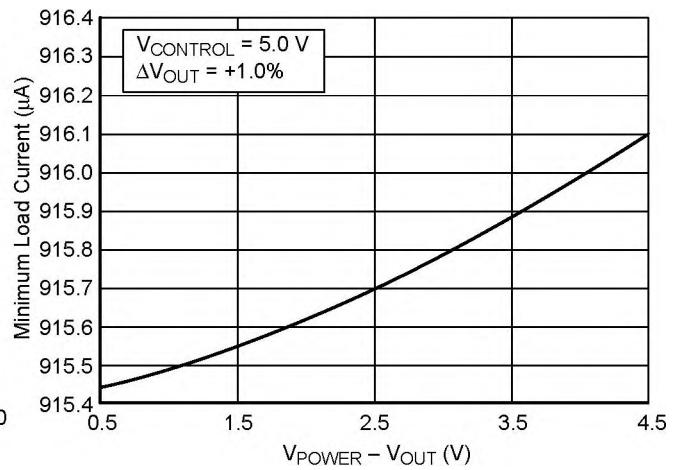Figure 13. V$_{POWER}$ Dropout Voltage vs Output Current

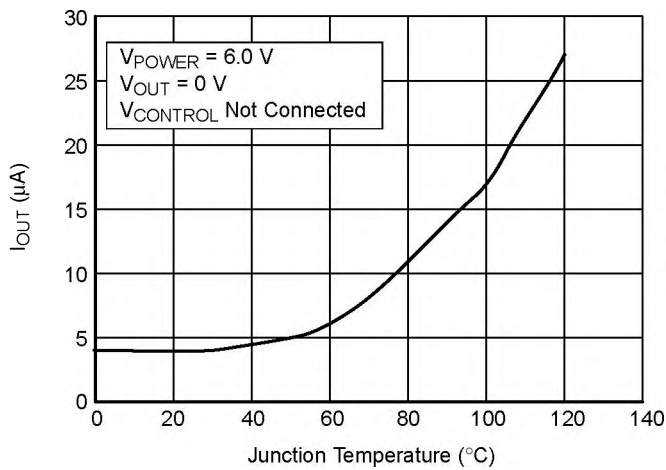Figure 14. Minimum Load Current vs V$_{POWER}$ – V$_{OUT}$

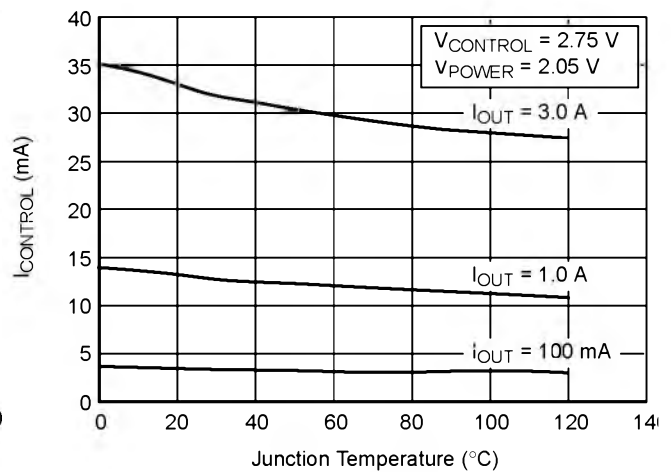Figure 15. V$_{POWER}$ Only Output Current vs Junction Temperature

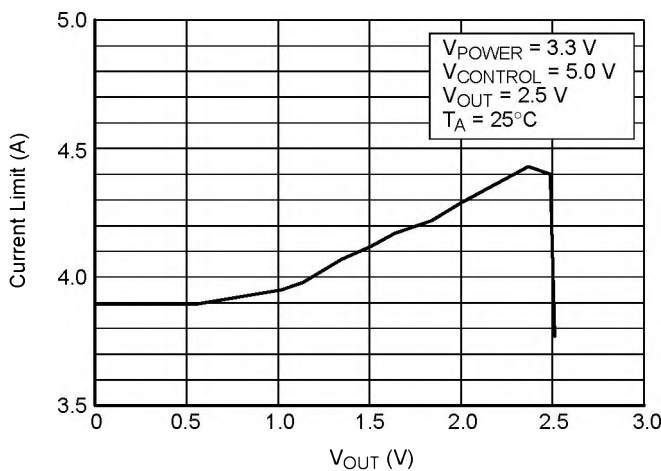Figure 16. V$_{CONTROL}$ Supply Current vs Junction Temperature

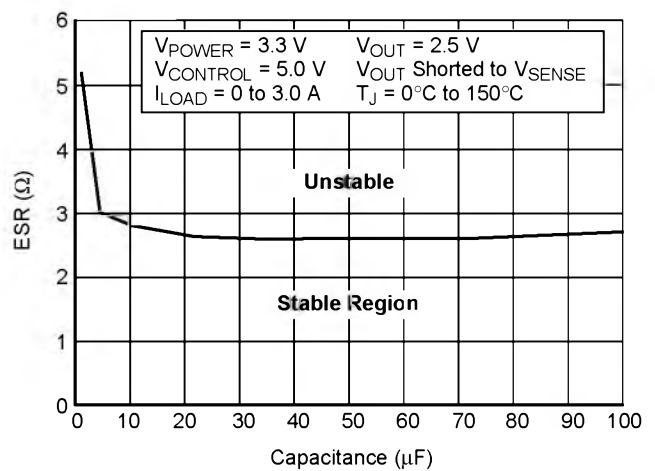Figure 17. Current Limit vs V$_{OUT}$

Figure 18. Stability vs ESR

APPLICATIONS NOTES

THEORY OF OPERATION

The CS5253–1 linear regulator provides adjustable voltages from 1.26 V to 5.0 V at currents up to 3.0 A. The regulator is protected against short circuits, and includes a thermal shutdown circuit with hysteresis. The output, which is current limited, consists of a PNP–NPN transistor pair and requires an output capacitor for stability. A detailed procedure for selecting this capacitor is included in the Stability Considerations section.

V_{POWER} Function

The CS5253–1 utilizes a two supply approach to maximize efficiency. The collector of the power device is brought out to the V_{POWER} pin to minimize internal power dissipation under high current loads. $V_{CONTROL}$ provides for the control circuitry and the drive for the output NPN transistor. $V_{CONTROL}$ should be at least 1.0 V greater than the output voltage. Special care has been taken to ensure that there are no supply sequencing problems. The output voltage will not turn on until both supplies are operating. If the control voltage comes up first, the output current will be limited to about three milliamperes until the power input voltage comes up. If the power input voltage comes up first, the output will not turn on at all until the control voltage comes up. The output can never come up unregulated.

The CS5253–1 can also be used as a single supply device with the control and power inputs tied together. In this mode, the dropout will be determined by the minimum control voltage.

Output Voltage Sensing

The CS5253–1 five terminal linear regulator includes a dedicated V_{SENSE} function. This allows for true Kelvin sensing of the output voltage. This feature can virtually eliminate errors in the output voltage due to load regulation. Regulation will be optimized at the point where the sense pin is tied to the output.

DESIGN GUIDELINES

Adjustable Operation

This LDO adjustable regulator has an output voltage range of 1.26 V to 5.0 V. An external resistor divider sets the output voltage as shown in Figure 19. The regulator's voltage sensing error amplifier maintains a fixed 1.260 V reference between the output pin and the adjust pin.
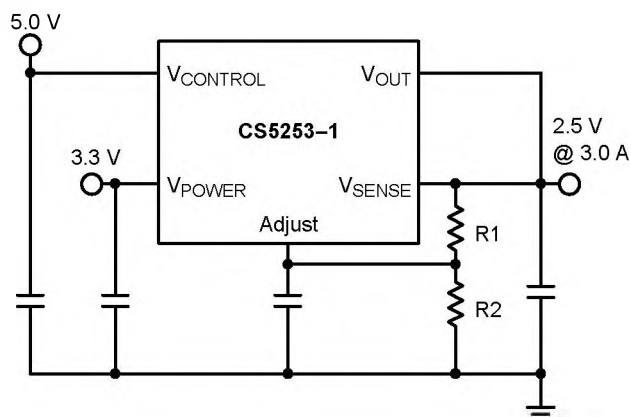

Figure 19. Typical Application Schematic. The Resistor Divider Sets V_{OUT}, With the Internal 1.260 V Reference Dropped Across R1.

A resistor divider network R1 and R2 causes a fixed current to flow to ground. This current creates a voltage across R2 that adds to the 1.260 V across R1 and sets the overall output voltage. The adjust pin current (typically 50 μA) also flows through R2 and adds a small error that should be taken into account if precise adjustment of V_{OUT} is necessary. The output voltage is set according to the formula:

$$V_{OUT} = 1.260\ V \times \frac{R1 + R2}{R1} + R2 \times I_{ADJ}$$

The term $I_{ADJ} \times R2$ represents the error added by the adjust pin current. R1 is chosen so that the minimum load current is at least 10 mA. R1 and R2 should be of the same composition for best tracking over temperature. The divider resistors should be placed physically as close to the load as possible.

While not required, a bypass capacitor connected between the adjust pin and ground will improve transient response and ripple rejection. A 0.1 μF tantalum capacitor is recommended for "first cut" design. Value and type may be varied to optimize performance vs. price.

Other Adjustable Operation Considerations

The CS5253–1 linear regulator has an absolute maximum specification of 6.0 V for the voltage difference between V_{POWER} and V_{OUT}. However, the IC may be used to regulate voltages in excess of 6.0 V. The two main

considerations in such a design are the sequencing of power supplies and short circuit capability.

Power supply sequencing should be such that the $V_{CONTROL}$ supply is brought up coincidentally with or before the V_{POWER} supply. This allows the IC to begin charging the output capacitor as soon as the V_{POWER} to V_{OUT} differential is large enough that the pass transistor conducts. As V_{POWER} increases, the pass transistor will remain in dropout, and current is passed to the load until V_{OUT} is in regulation. Further increase in the supply voltage brings the pass transistor out of dropout. In this manner, any output voltage less than 13 V may be regulated, provided the V_{POWER} to V_{OUT} differential is less than 6.0 V. In the case where $V_{CONTROL}$ and V_{POWER} are shorted, there is no theoretical limit to the regulated voltage as long as the V_{POWER} to V_{OUT} differential of 6.0 V is not exceeded.

There is a possibility of damaging the IC when V_{POWER} – V_{OUT} is greater than 6.0 V if a short circuit occurs. Short circuit conditions will result in the immediate operation of the pass transistor outside of its safe operating area. Overvoltage stresses will then cause destruction of the pass transistor before overcurrent or thermal shutdown circuitry can become active. Additional circuitry may be required to clamp the V_{POWER} to V_{OUT} differential to less than 6.0 V if fail safe operation is required. One possible clamp circuit is illustrated in Figure 20; however, the design of clamp circuitry must be done on an application by application basis. Care must be taken to ensure the clamp actually protects the design. Components used in the clamp design must be able to withstand the short circuit condition indefinitely while protecting the IC.
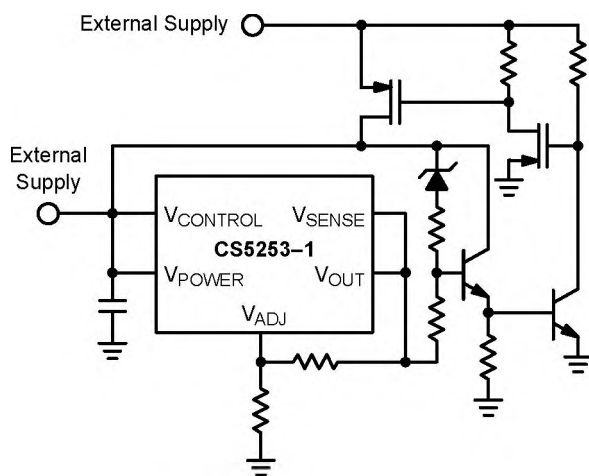

Figure 20. This Circuit Is an Example of How the CS5253–1 Can Be Short–Circuit Protected When Operating With V_{OUT} > 6.0 V

Stability Considerations

The output compensation capacitor helps determine three main characteristics of a linear regulator: loop stability, start–up delay, and load transient response. Different capacitor types vary widely in tolerance, ESR (equivalent series resistance), ESL (equivalent series inductance), and variation over temperature. Tantalum and aluminum electrolytic capacitors work best, with electrolytic capacitors being less expensive in general, but varying more in capacitor value and ESR over temperature.

The CS5253–1 requires an output capacitor to guarantee loop stability. The Stability vs ESR graph in the typical performance section shows the minimum ESR needed to guarantee stability, but under ideal conditions. These include: having V_{OUT} connected to V_{SENSE} directly at the IC pins; the compensation capacitor located right at the pins with a minimum lead length; the adjust feedback resistor divider ground, (bottom of R2 in Figure 19), connected right at the capacitor ground; and with power supply decoupling capacitors located close to the IC pins. The actual performance will vary greatly with board layout for each application. In particular, the use of the remote sensing feature will require a larger capacitor with less ESR. For most applications, a minimum of 33 µF tantalum or 150 µF aluminum electrolytic, with an ESR less than 1.0 Ω over temperature, is recommended. Larger capacitors and lower ESR will improve stability.

The load transient response, during the time it takes the regulator to respond, is also determined by the output capacitor. For large changes in load current, the ESR of the output capacitor causes an immediate drop in output voltage given by:

$$\Delta V = \Delta I \times ESR$$

There is then an additional drop in output voltage given by:

$$\Delta V = \Delta I \times T/C$$

where T is the time for the regulation loop to begin to respond. The very fast transient response time of the CS5253–1 allows the ESR effect to dominate. For microprocessor applications, it is customary to use an output capacitor network consisting of several tantalum and ceramic capacitors in parallel. This reduces the overall ESR and reduces the instantaneous output voltage drop under transient load conditions. The output capacitor network should be as close to the load as possible for the best transient response.

Protection Diodes

When large external capacitors are used with a linear regulator, it is sometimes necessary to add protection diodes. If the input voltage of the regulator gets shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage, and the rate at which $V_{CONTROL}$ drops. In the CS5253–1 regulator, the discharge path is through a large junction and protection diodes are not usually needed. If the regulator is used with large values of output capacitance and the input voltage is instantaneously shorted to ground, damage can occur. In this case, a diode connected as shown in Figure 21 is recommended.
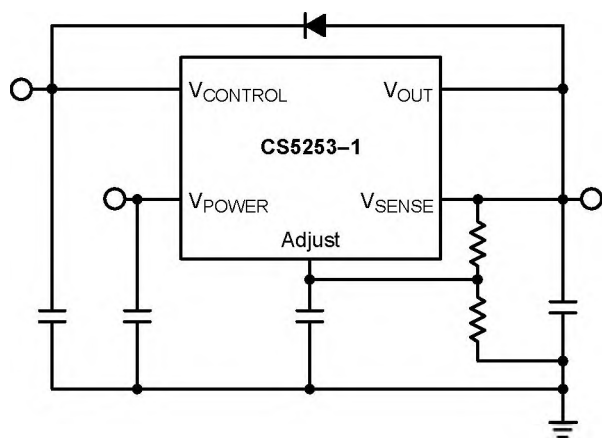
Figure 21. Diode Protection Circuit

A rule of thumb useful in determining if a protection diode is required is to solve for current:

$$i = \frac{C \times V}{T}$$

where:

I is the current flow out of the load capacitance when $V_{CONTROL}$ is shorted,

C is the value of load capacitance

V is the output voltage, and

T is the time duration required for $V_{CONTROL}$ to transition from high to being shorted.

If the calculated current is greater than or equal to the typical short circuit current value provided in the specifications, serious thought should be given to the use of a protection diode.

Current Limit

The internal current limit circuit limits the output current under excessive load conditions.

Short Circuit Protection

The device includes short circuit protection circuitry that clamps the output current at approximately 500 mA less than its current limit value. This provides for a current foldback function, which reduces power dissipation under a direct shorted load.

Thermal Shutdown

The thermal shutdown circuitry is guaranteed by design to activate above a die junction temperature of approximately 150°C and to shut down the regulator output. This circuitry has 25°C of typical hysteresis, thereby allowing the regulator to recover from a thermal fault automatically.

Calculating Power Dissipation and Heat Sink Requirements

High power regulators such as the CS5253–1 usually operate at high junction temperatures. Therefore, it is important to calculate the power dissipation and junction temperatures accurately to ensure that an adequate heat sink is used. Since the package tab is connected to V_{OUT} on the CS5253–1, electrical isolation may be required for some applications. Also, as with all high power packages, thermal compound in necessary to ensure proper heat flow. For added safety, this high current LDO includes an internal thermal shutdown circuit

The thermal characteristics of an IC depend on the following four factors: junction temperature, ambient temperature, die power dissipation, and the thermal resistance from the die junction to ambient air. The maximum junction temperature can be determined by:

$$T_{J(max)} = T_{A(max)} + P_{D(max)} \times R_{\Theta JA}$$

The maximum ambient temperature and the power dissipation are determined by the design while the maximum junction temperature and the thermal resistance depend on the manufacturer and the package type. The maximum power dissipation for a regulator is:

$$P_{D(max)} = (V_{IN(max)} - V_{OUT(min)})I_{OUT(max)} + V_{IN(max)} \times I_{IN(max)}$$

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air. Each material in the heat flow path between the IC and the outside environment has a thermal resistance which is measured in degrees per watt. Like series electrical resistances, these thermal resistances are summed to determine the total thermal resistance between the die junction and the surrounding air, $R_{\Theta JA}$. This total thermal resistance is comprised of three components. These resistive terms are measured from junction to case ($R_{\Theta JC}$), case to heat sink ($R_{\Theta CS}$), and heat sink to ambient air ($R_{\Theta SA}$). The equation is:

$$R_{\Theta JA} = R_{\Theta JC} + R_{\Theta CS} + R_{\Theta SA}$$

The value for R_{QJC} is 2.5°C/watt for the CS5253–1 in the D²PAK package. For a high current regulator such as the CS5253–1 the majority of heat is generated in the power transistor section. The value for $R_{\Theta SA}$ depends on the heat sink type, while the $R_{\Theta CS}$ depends on factors such as package type, heat sink interface (is an insulator and thermal grease used?), and the contact area between the heat sink and the package. Once these calculations are complete, the maximum permissible value of $R_{\Theta JA}$ can be calculated and the proper heat sink selected. For further discussion on heat sink selection, see our application note "Thermal Management for Linear Regulators," document number SR006AN/D, available through the Literature Distribution Center or via our website at http://www.onsemi.com.

CS5253–1

PACKAGE THERMAL DATA

Parameter		D^{2}PAK, 5–Pin	Unit
$R_{\Theta JC}$	Typical	2.5	°C/W
$R_{\Theta JA}$	Typical	10–50*	°C/W

*Depending on thermal properties of substrate. $R_{\Theta JA} = R_{\Theta JC} + R_{\Theta CA}$.